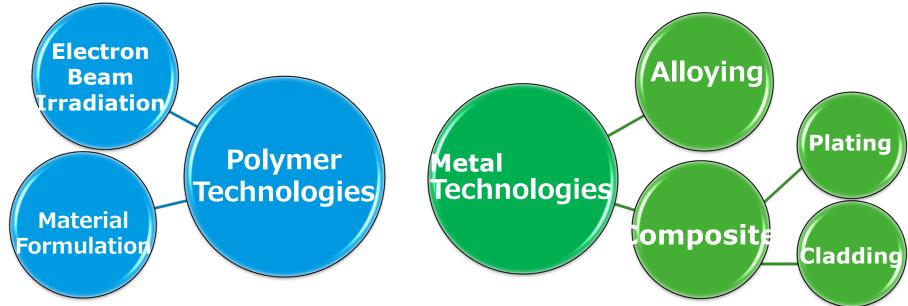


# Core Technologies of SEI Products for the Electronics Market

Sumitomo Electric Industries, Ltd. Interconnect Innovation Project Team April, 2021

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# **Overview of the Core Technologies**



SEI has been developing and modifying our products for the electronics market, by utilizing our core technologies such as polymer technologies including electron beam irradiation and material formulation, as well as metal technologies including alloying and composite such as plating and cladding. The details are explained in the following slides.

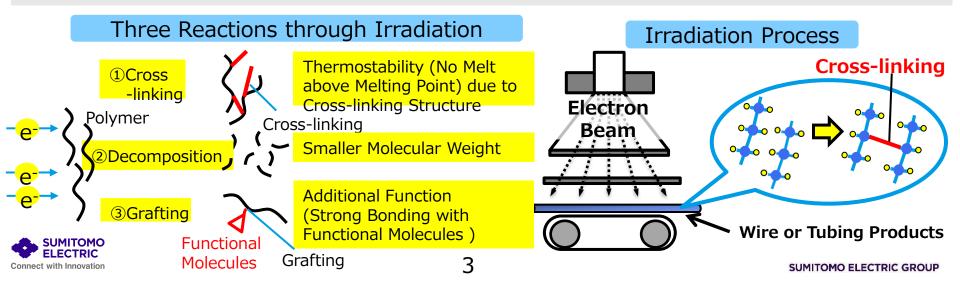
If you have any technical issues that could be solved by our technologies, please feel free to contact us.

Contact: iipt@info.sei.co.jp



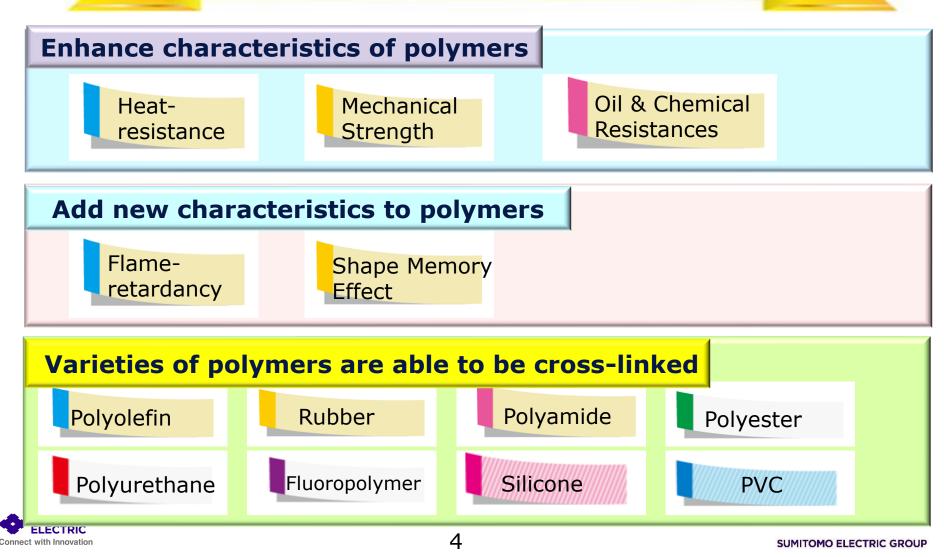
#### What is Electron Beam Irradiation?

- Applying electron beam irradiation on polymers such as polyethylene causes three reactions including cross-linking, decomposition, and grafting. SEI has developed various products by using cross-linking or grafting.
- Cross-linking is chemical reaction that creates intermolecular bonds. This attains characteristics such as heat-resistance, oil and chemical resistances, mechanical strength, and shape memory effect.
- Decomposition of polymer chains also occurs at the same time. In case cross-linking exceeds decomposition, cross-linking effect can be utilized.
- Grafting is chemical reaction that adds new characteristics to polymer by bonding molecules which have different functions such as frame-retardancy, to the trunk of the polymer.
- The principle of electron beam irradiation is the same as that of CRT television and it is safe as the irradiation is completely suspended by power-off. Irradiated products are chemically stable and have been used for many years.

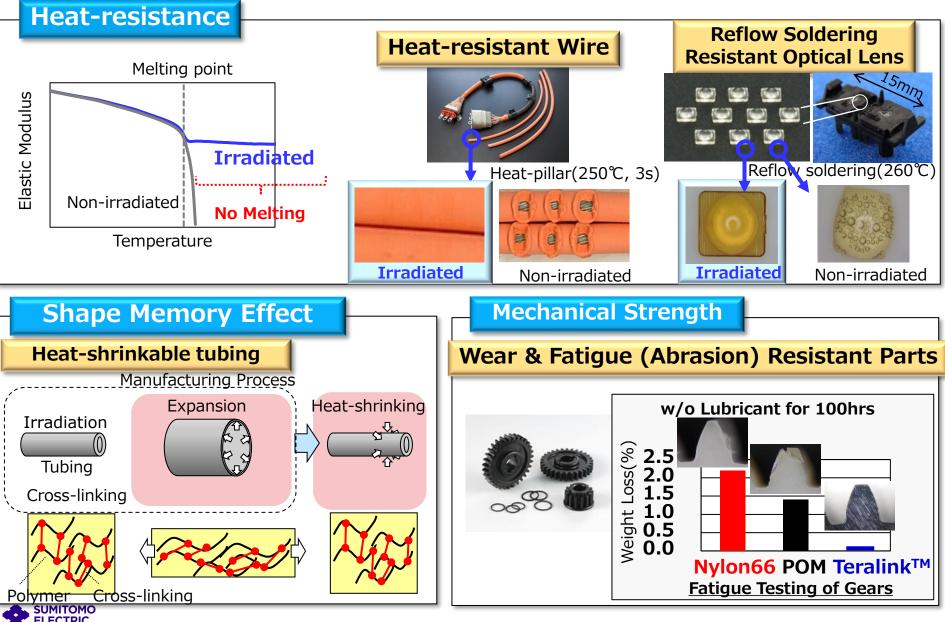


# **Benefits of Electron Beam Irradiation**

The following characteristics are able to be enhanced or added to "Finished Products".

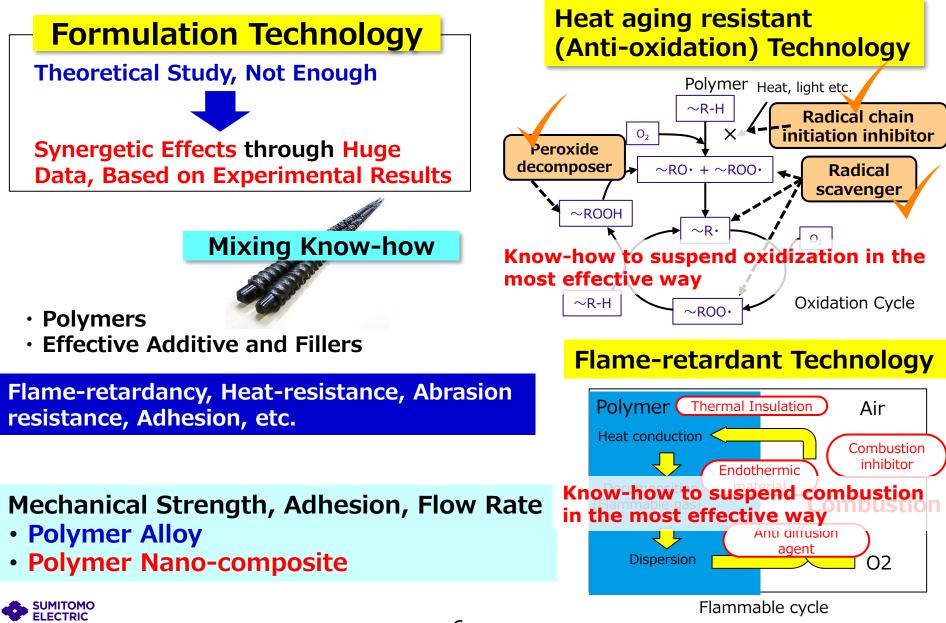


## **Applications of Electron Beam Irradiation**



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# **Material Formulation Technology**

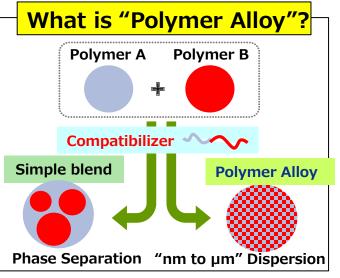


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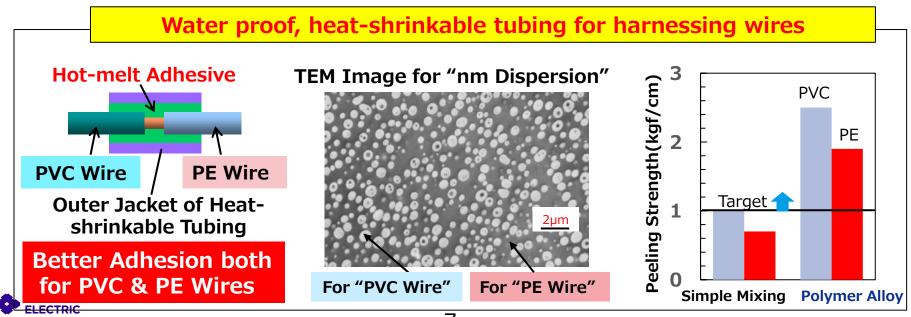
## **Polymer Alloy Technology**

★ Fine dispersion
technology to mix
mutually immiscible
polymers
★ Create new material
with merits of both
polymers

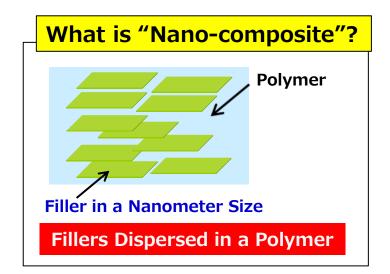
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# Benefits Adhesion Greater peeling strength Better adhesion to multiple materials Mechanical Strength Rigidity and impact resistance Flexibility and abrasion resistance



## **Polymer Nano-composite Technology**

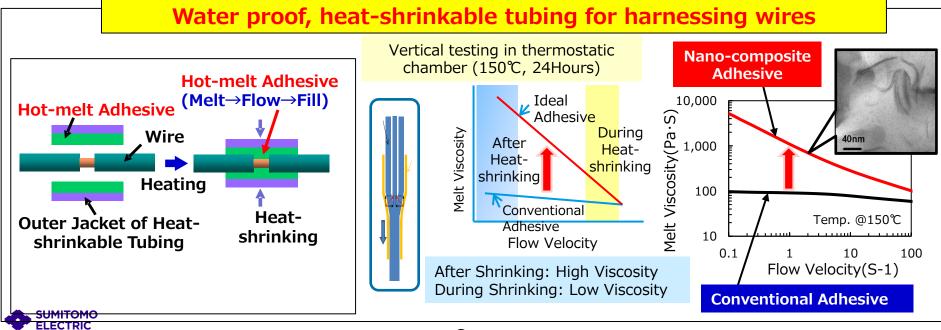


#### Benefits

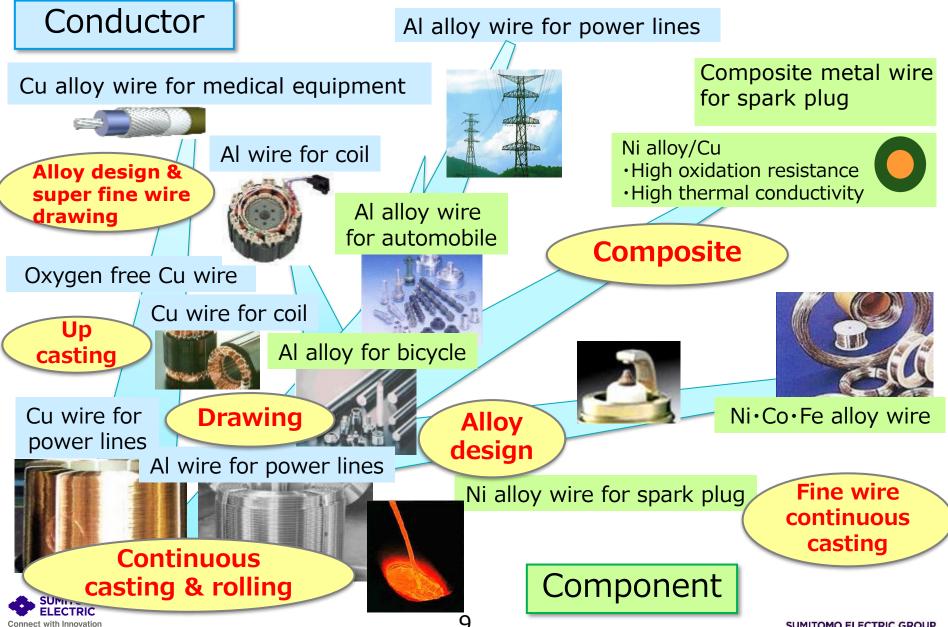
#### **Mechanical Strength**

Greater tensile strength Better flexural rigidity Adhesive Property

Low flow rate @ elevated temperature, after installation High flow rate during heatshrinking

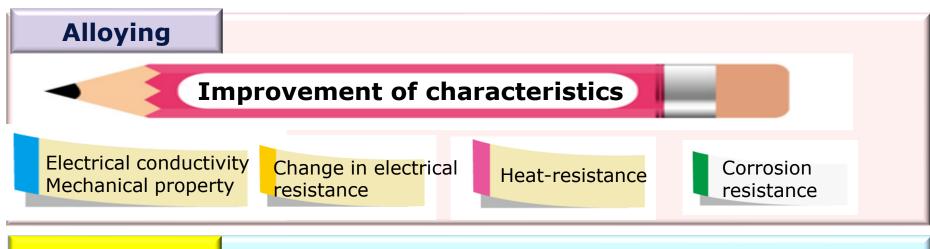


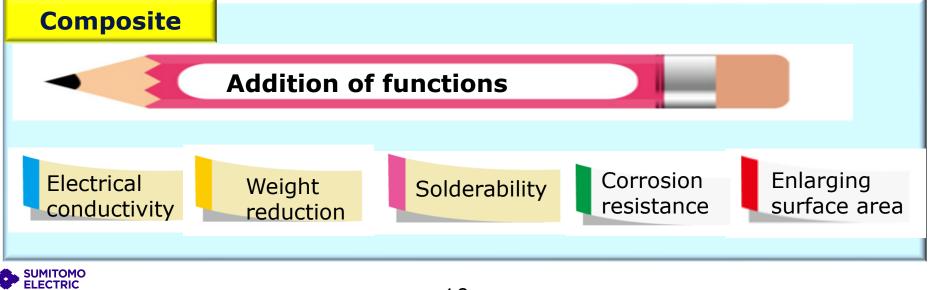
#### **Metal Technologies and Applications**



# **Metal Technologies**

# Improvement of characteristics by alloying, and addition of functions by composite





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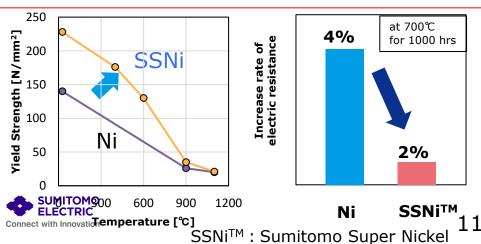
# **Alloying Technology**

#### Ni Alloy Wire (SSNi<sup>™</sup>)

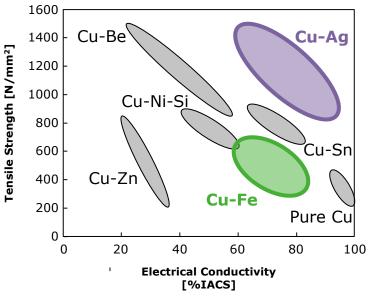
SSNi<sup>™</sup> possesses higher oxidation resistance and stabler electrical property at high temperature than pure nickel due to the intermetallic compound precipitations.



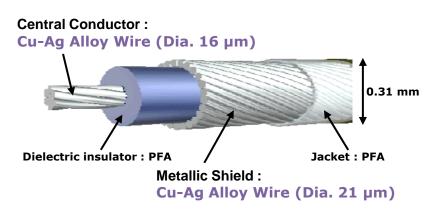
Comparison of yield strength and electric resistance change at high temperature between SSNi<sup>™</sup> and Ni



#### **High Strength Cu Alloy**



#### Application for medical equipment cable



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# Composite Technologies Composite by cladding

Cladding is a technology to fit metal layer on another metal mechanically. SEI produces composite wire by unique cladding technology.

Cu clad Al (CCA) : Core material is light and high strength Al alloy and outer layer is copper. Specific gravity is about half of Cu.

Cu clad Al (CCA)		Light Weight	Electrical Conductivity	Solderability	Corrosion Resistance *
Cu layer	Cu/Al Composite	0	0	Ø	×
Al Alloy	Al Alloy	O	$\bigtriangleup$	×	$\bigcirc$
	Cu Alloy	×	Ø	Ø	$\bigtriangleup$

\* Corrosion resistance can be improved by processing terminal cross section.

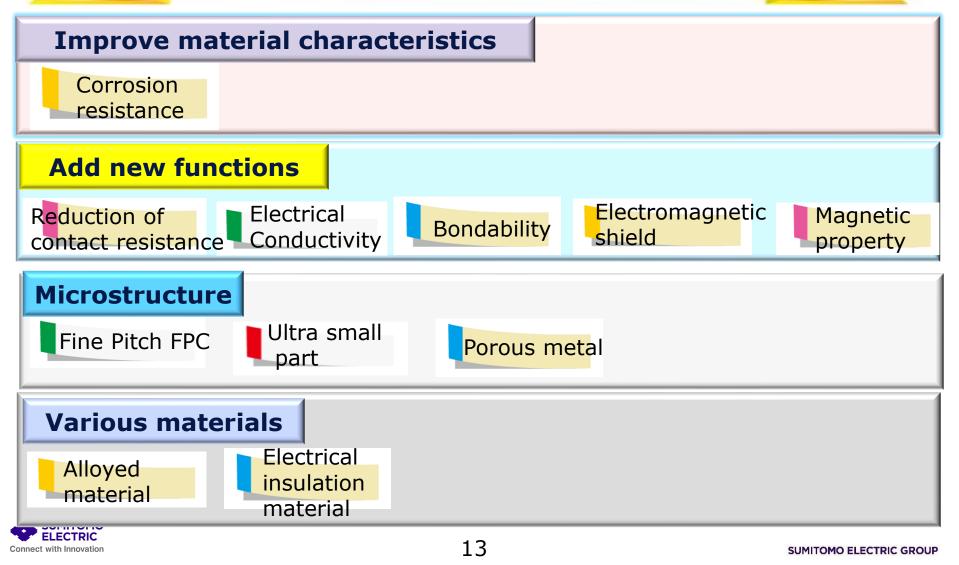
## **Composite by plating**

SEI produces composite material by covering metal on another metal by unique plating technology. <u>Ni Plated Cu Composite Wire</u>

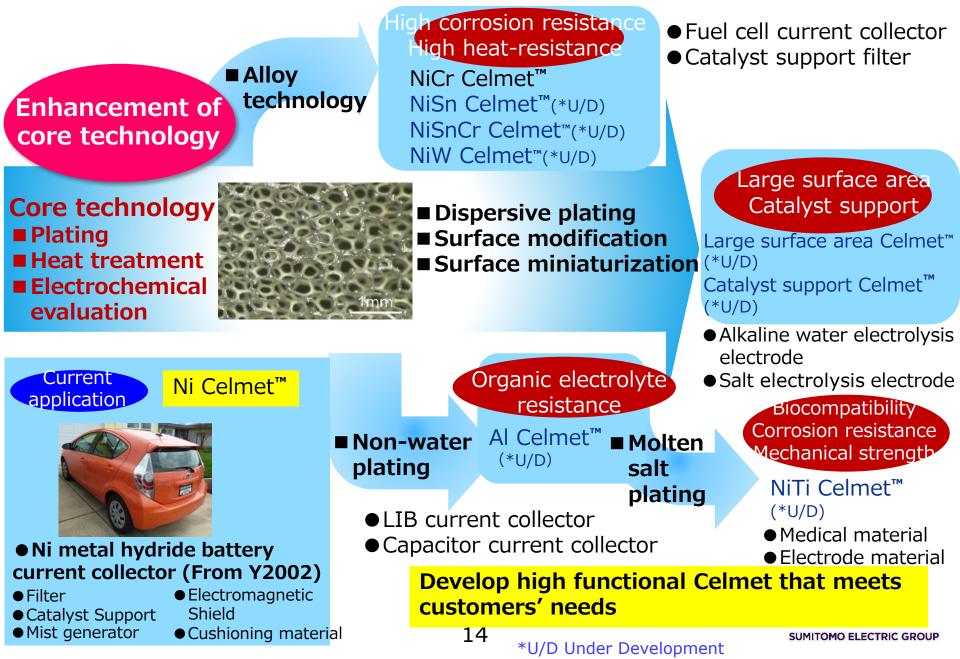
conductor res	– Heat- resistant	High frequency conductor		Heat- Resistance	Electrical Conductivity	Solderability	Corrosion Resistance
	conductor		Ni/Cu Plating	0	0	0	0
	Cu	Cu	Ni Alloy	O	×	$\bigcirc$	$\bigcirc$
Sn	Ni	Âg	Cu Alloy	×	$\bigcirc$	Ø	$\bigtriangleup$
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# **Plating Technology**

Improving material characteristics, adding new functions, making microstructure and plating on various materials



#### "Application of plating" to porous metal, Celmet™





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